



## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

## In re Application of:

James M. Derderian

**Serial No.:** 10/770,890

Filed: February 2, 2004

For: METHODS FOR FORMING
ASSEMBLIES AND PACKAGES THAT
INCLUDE STACKED SEMICONDUCTOR
DEVICES SEPARATED A DISTANCE
DEFINED BY ADHESIVE MATERIAL
INTERPOSED THEREBETWEEN

Confirmation No.: Unknown

Examiner: Unknown

Group Art Unit: Unknown

Attorney Docket No.: 2269-4817.3US

## CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

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April 7, 2004 Date

> Deidra J. Pfeil Name (Type/Print)

## PRELIMINARY AMENDMENT

Mail Stop Non-Fee Amendment Commissioner for Patents P.O. Box 1450 Alexandria, Virginia 22313-1450

Sir:

Please revise the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 8 of this paper.